onsemi

MOSFET – N-Channel, POWERTRENCH[®]

80 V, 30 A, 22 m Ω

FDMS86381-F085

Features

- Typ $R_{DS(on)} = 17.2 \text{ m}\Omega$ at $V_{GS} = 10 \text{ V}$; $I_D = 30 \text{ A}$
- Typ $Q_{g(tot)} = 14 \text{ nC}$ at $V_{GS} = 10 \text{ V}$; $I_D = 30 \text{ A}$
- UIS Capability
- AEC-Q101 Qualified and PPAP Capable
- This Device is Pb–Free, Halogen Free/BFR Free and is RoHS Compliant

Applications

- Automotive Engine Control
- PowerTrain Management
- Solenoid and Motor Drivers
- Electronic Steering
- Integrated Starter/Alternator
- Distributed Power Architectures and VRM
- Primary Switch for 12 V Systems

MOSFET MAXIMUM RATINGS (T_J = 25° C unless otherwise noted)

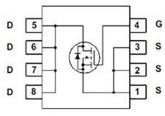
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Parameter		Symbol	Value	Unit
Drain-to-Source Voltage	Drain-to-Source Voltage		80	V
Gate-to-Source Voltage		V _{GS}	±20	V
Continuous Drain Current (V _{GS} = 10 V) (Note 1)	T _C = 25°C	۱ _D	30	A
Pulsed Drain Current	T _C = 25°C		See Figure 4	
Single Pulse Avalanche Energy (Note 2)		E _{AS}	11.5	mJ
Power Dissipation		PD	50	W
Derate above 25°C			0.33	W/°C
Operating and Storage Temperature		T _J , T _{STG}	–55 to +175	°C
Thermal Resistance (Junction-to-Case)		$R_{\theta JC}$	3	°C/W
Maximum Thermal Resistance (Junction-to-Ambient) (Note 3)		$R_{\theta JA}$	50	°C/W

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

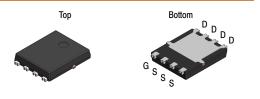
- 1. Current is limited by bondwire configuration.
- 2. Starting Tj = 25°C, L = 40 μ H, I_{AS} = 24 A, V_{DD} = 80 V during inductor charging and V_{DD} = 0 V during time in avalanche.
- 3. R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0JC} is guaranteed by design while R_{0JA} is determined by the user's board design. The maximum rating presented here is based on mounting on a 1 in² pad of 2 oz copper.

V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
80 V	$22 \text{ m}\Omega @ 10 \text{ V}$	30 A

ELECTRICAL CONNECTION

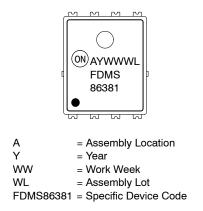


N-Channel MOSFET



DFNW8 CASE 507AU

MARKING DIAGRAM



ORDERING INFORMATION

Device	Package	Shipping [†]
FDMS86381-F085	DFNW8 (Power 56) (Pb–Free)	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise specified)

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
OFF CHARA	DFF CHARACTERISTICS						
B _{VDSS}	Drain-to-Source Breakdown Voltage	$I_D=250~\mu\text{A},~V_{GS}=0~\text{V}$		80	-	-	V
I _{DSS}	Drain-to-Source Leakage Current	$V_{DS} = 80 V,$	$T_{\rm J} = 25^{\circ}C$	-	-	1	μA
		$V_{GS} = 0 V$	T _J = 175°C (Note 4)	-	-	1	mA
I _{GSS}	Gate-to-Source Leakage Current	$V_{GS} = \pm 20 \text{ V}$		-	-	±100	nA

ON CHARACTERISTICS

V _{GS(th)}	Gate-to-Source Threshold Voltage	$V_{GS}=V_{DS},I_{D}=250$	μΑ	2.0	2.9	4.0	V
R _{DS(on)}	Drain-to-Source On-Resistance	$I_{\rm D} = 30 \rm{A}$	$T_J = 25^{\circ}C$	-	17.2	22.0	mΩ
		V _{GS} = 10 V	T _J = 175°C (Note 4)	-	37.7	48.2	

DYNAMIC CHARACTERISTICS

C _{iss}	Input Capacitance	$V_{DS} = 40 \text{ V}, V_{GS} = 0$	V, f = 1 MHz	-	866	-	pF
C _{oss}	Output Capacitance			-	176	-	
C _{rss}	Reverse Transfer Capacitance			-	7	-	
Rg	Gate Resistance	f = 1 MHz		-	2.3	-	Ω
Q _{g(tot)}	Total Gate Charge	V_{GS} = 0 to 10 V	V _{DD} = 40 V,	-	14	21	nC
Q _{g(th)}	Threshold Gate Charge	V_{GS} = 0 to 2 V	I _D = 30 A	-	1.7	-	
Q _{gs}	Gate-to-Source Gate Charge		-	-	5.1	-	
Q _{gd}	Gate-to-Drain "Miller" Charge			-	3.8	-	

SWITCHING CHARACTERISTICS

t _{on}	Turn-On Time	V _{DD} = 40 V, I _D = 30 A, V _{GS} = 10 V, R _{GEN} = 6 Ω	-	-	23	ns
t _{d(on)}	Turn-On Delay	$v_{\rm GS}$ = 10 v, $R_{\rm GEN}$ = 6 S2	-	9	-	
t _r	Rise Time		-	6	-	
t _{d(off)}	Turn-Off Delay		-	14	-	
t _f	Fall Time		-	5	-	
t _{off}	Turn-Off Time		-	-	28	

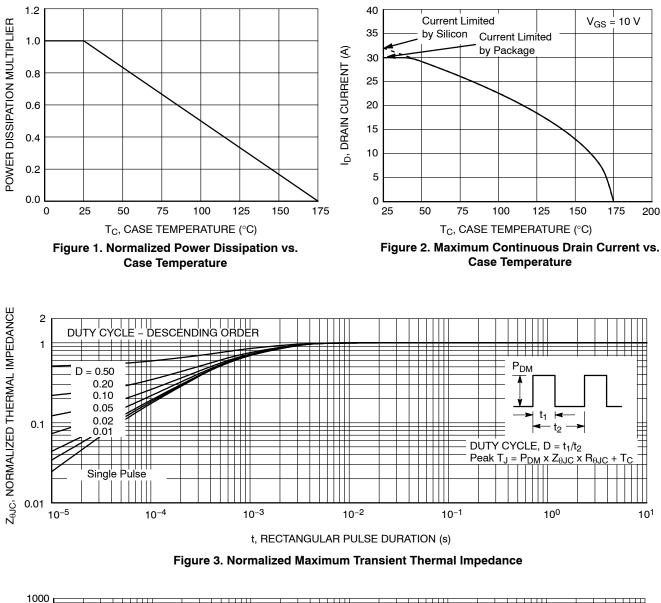
DRAIN-SOURCE DIODE CHARACTERISTICS

V _{SD}	Source-to-Drain Diode Voltage	I _{SD} = 30 A, V _{GS} = 0 V	-	-	1.25	V
		I _{SD} = 15 A, V _{GS} = 0 V	-	-	1.2	
t _{rr}	Reverse Recovery Time	I_F = 30 A, dI_{SD}/dt = 100 A/µs, V_{DD} = 64 V	-	34	50	ns
Q _{rr}	Reverse Recovery Charge		-	27	40	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. The maximum value is specified by design at $T_J = 175^{\circ}$ C. Product is not tested to this condition in production

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TYPICAL CHARACTERISTICS



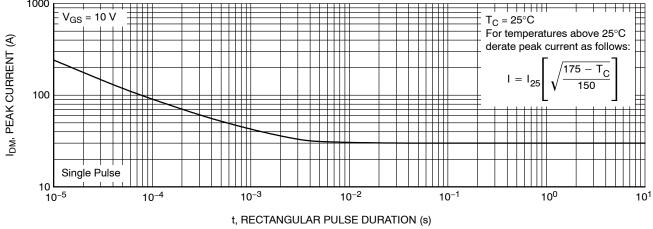
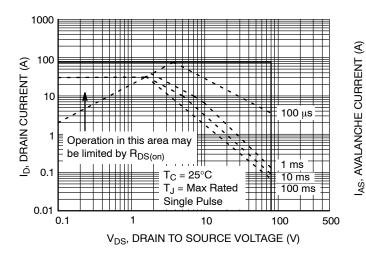


Figure 4. Peak Current Capability

TYPICAL CHARACTERISTICS (Continued)



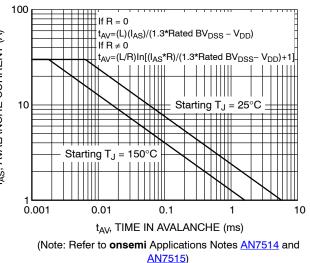
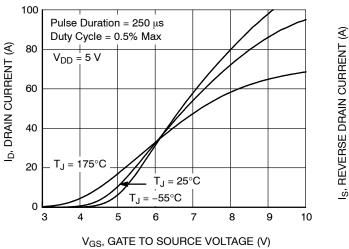


Figure 5. Forward Bias Safe Operating Area





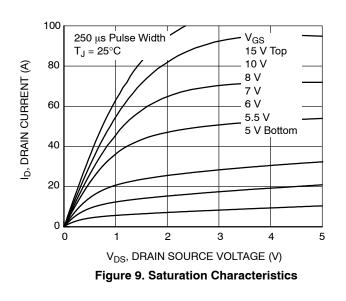


Figure 6. Unclamped Inductive Switching Capability

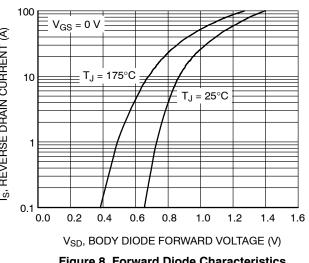
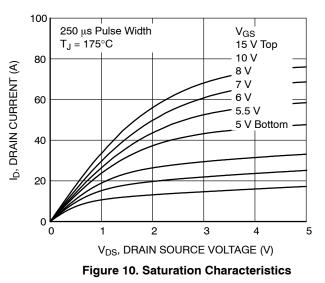
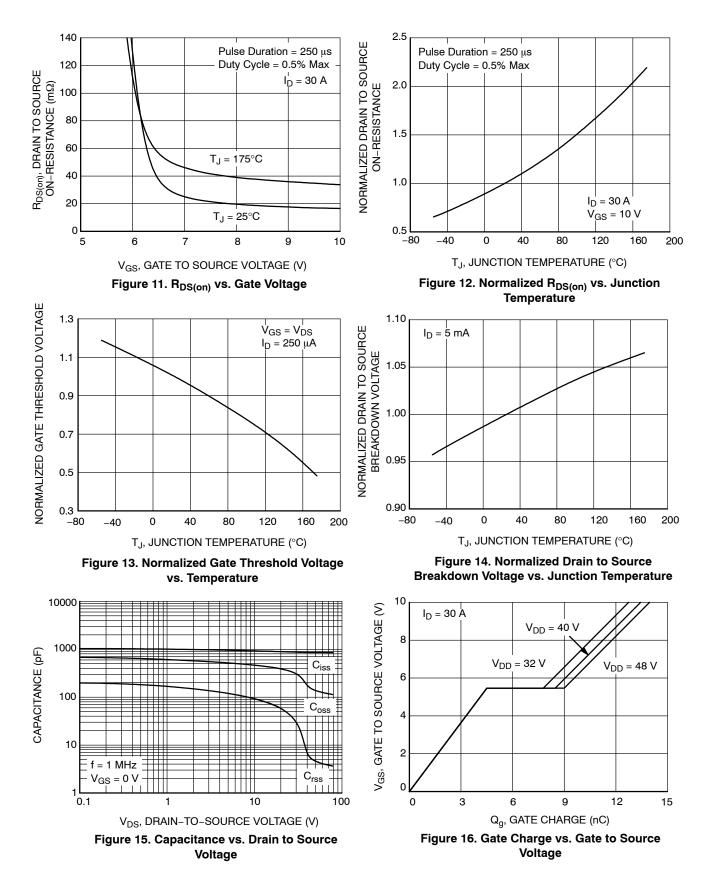


Figure 8. Forward Diode Characteristics



TYPICAL CHARACTERISTICS (Continued)



SEI

(2X)

1.42

6.91

MAX.

1.10

0.05

0.85

0.57

0.23

5.20

5.00

3.92

6.40

5.90

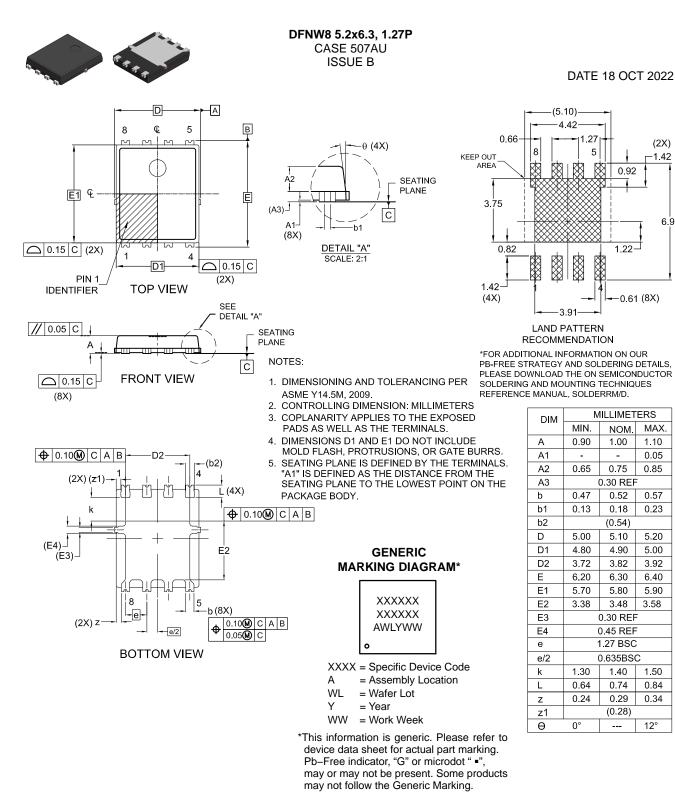
3.58

1.50

0.84

0.34

12°



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